

Bipolar Transistors Silicon PNP Epitaxial Type

2SA1832

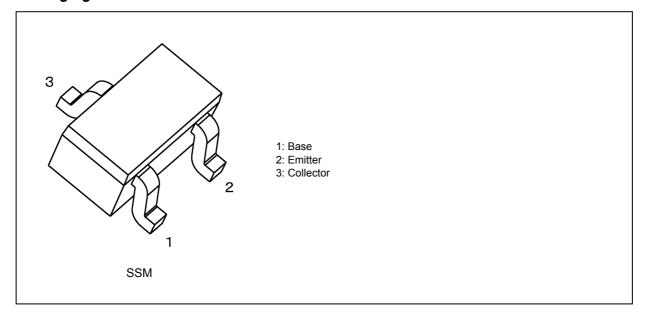
1. Applications

• Low-Frequency Amplifiers

2. Features

- (1) AEC-Q101 qualified (Please see the orderable part number list)
- (2) High voltage: $V_{CEO} = -50 \text{ V}$
- (3) High collector current: $I_C = -150 \text{ mA (max)}$
- (4) High h_{FE} : $h_{FE} = 70$ to 400
- (5) Excellent h_{FE} linearity: h_{FE} ($I_{C} = -0.1$ mA)/ h_{FE} ($I_{C} = -2$ mA) = 0.95 (typ.)
- (6) Complementary to 2SC4738
- (7) Small package

3. Packaging





4. Orderable part number

Orderable part number		AEC-Q101	AEC-Q101		Note		
2SA1832-O	2SA1832-O,LF	_		General Use			
	2SA1832-O,LXGF	YES	(Note 1)	Unintended Use	(Note 1)		
	2SA1832-O,LXHF	YES		Automotive Use			
2SA1832-Y	2SA1832-Y,LF	_		General Use			
	2SA1832-Y,LXGF	YES	(Note 1)	Unintended Use	(Note 1)		
	2SA1832-Y,LXHF	YES		Automotive Use			
2SA1832-GR	2SA1832-GR,LF	_		General Use			
	2SA1832-GR,LXGF	YES	(Note 1)	Unintended Use	(Note 1)		
	2SA1832-GR,LXHF	YES		Automotive Use			

Note 1: For more information, please contact our sales or use the inquiry form on our website.

5. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics			Rating	Unit
Collector-base voltage		V _{CBO}	-50	V
Collector-emitter voltage			-50	V
Emitter-base voltage		V_{EBO}	-5	V
Collector current (DC)			-150	mA
Base current			-30	mA
Collector power dissipation	(Note 2), (Note 4)	P_{C}	120	mW
	(Note 3)		100	
Junction temperature	(Note 2)	Tj	150	°C
	(Note 3)		125	
Storage temperature	(Note 2)	T _{stg}	-55 to 150	°C
	(Note 3)		-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: For devices with the ordering part number ending in LF(T.
- Note 3: For devices with the ordering part number ending in XGF(T, XHF(T.
- Note 4: Device mounted on an 25.4 mm \times 25.4 mm \times 1.6 mm FR4 glass epoxy board (Cu pad: 0.36 mm $^2 \times$ 3)

6. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

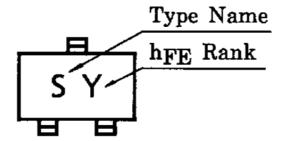
Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}		$V_{CB} = -50 \text{ V}, I_{E} = 0 \text{ A}$	_	_	-0.1	μА
Emitter cut-off current	I _{EBO}		$V_{EB} = -5 \text{ V}, I_{C} = 0 \text{ mA}$	_		-0.1	μА
DC current gain	h _{FE}	(Note 5)	$V_{CE} = -6 \text{ V}, I_{C} = -2 \text{ mA}$	70		400	_
Collector-emitter saturation voltage	V _{CE(sat)}		$I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$	_	-0.1	-0.3	V
Transition frequency	f _T		$V_{CE} = -10 \text{ V}, I_{C} = -1 \text{ mA}$	80	_	_	MHz
Collector output capacitance	C _{ob}		V _{CB} = -10 V, I _E = 0 A, f = 1 MHz	_	4	7	pF

Note 5: h_{FE} classification O (O): 70 to 140, Y (Y): 120 to 240, GR (G): 200 to 400

() marking symbol

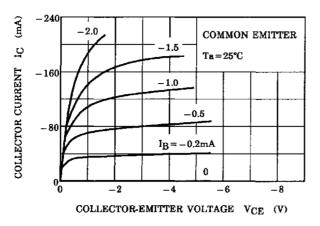


7. Marking





8. Characteristics Curves (Note)



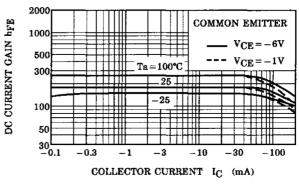
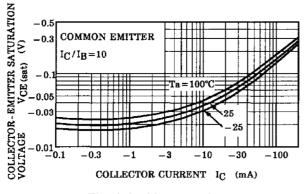


Fig. 8.1 Ic - VCE

Fig. 8.2 hFE - IC



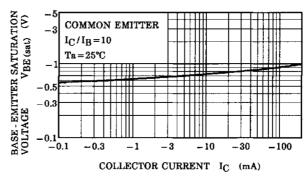
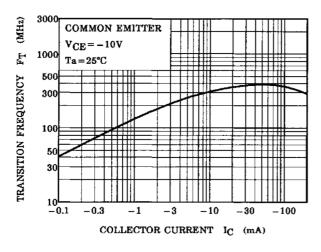


Fig. 8.3 V_{CE(sat)} - I_C

Fig. 8.4 V_{BE(sat)} - I_C



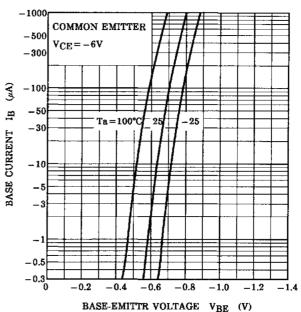


Fig. 8.5 f_T - I_C

Fig. 8.6 IB - VBE



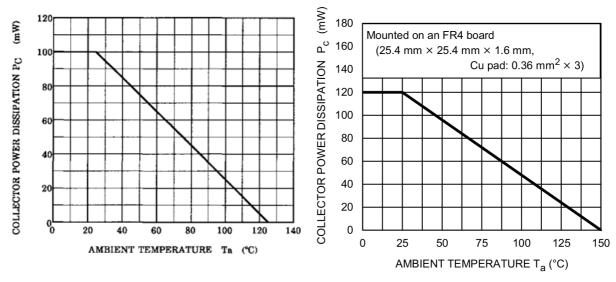


Fig. 8.7 $\;$ PC - T_a Reference only with T_j of 125 $^{\circ} C.$

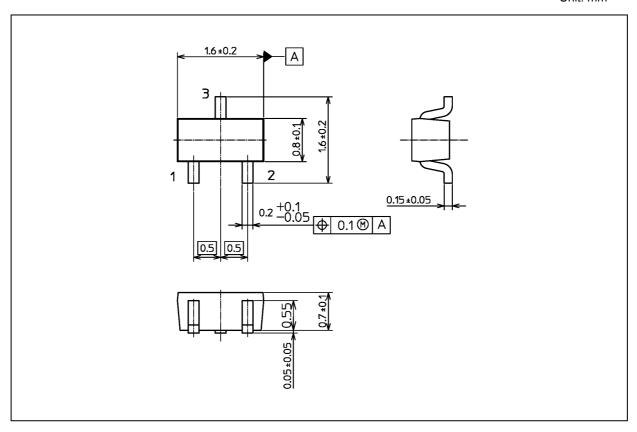
Fig. 8.8 P_C - T_a Reference only with T_j of 150 $^{\circ}$ C.

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 2.4 mg (typ.)

Package Name(s)		
TOSHIBA: 2-2H1S		
Nickname: SSM		



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